

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	10	("5795162" "5816826" "6081430" "6097612" "6287132" "6297779" "6392160").PN. OR ("6574115").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/26 16:13
L2	4	("2003/0042621").URPN.	USPAT	OR	ON	2005/09/26 16:15
L3	18	("5332864" "5442230").PN. OR ("5569955").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/26 16:17
S1	3473	174/261	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/24 08:31
S2	1926	S1 and @py>"1999"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/24 09:05
S3	1547	S1 not S2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/24 09:06
S4	674	(361/803).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/12 11:21
S5	3429	174/261	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/12 11:21
S6	560	S4 not S5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/12 11:21
S7	17	("5477082" "5583378" "5659952" "5729051" "5814883" "5834839").PN. OR ("5999415").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/12 11:29
S8	46	("4922324" "5008734" "5343076" "5422615" "5455456" "5463250" "5491362" "5521332" "5541450").PN. OR ("5814883").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/12 11:37

S9	17	hemispherical adj solder adj ball	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/12 11:37
S10	1446	(361/785-791).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/14 15:40
S11	16	("3377678" "3674914").PN. OR ("4000558").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 16:03
S12	46	("4922324" "5008734" "5343076" "5422615" "5455456" "5463250" "5491362" "5521332" "5541450").PN. OR ("5814883").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 16:03
S13	64	("3326726" "3337838" "3366915" "3444506" "3848221" "4274700" "4487463" "4530002" "4572604" "4616406" "4654472" "4655526" "4667220" "4698663" "4724472" "4734042" "4897055" "4943846" "4959750" "4975066" "4997376" "5015207" "5037311" "5071363" "5081563" "5106461" "5110760" "5117069" "5123164" "5137456" "5200357" "5281151" "5309024" "5326936" "5330372" "5334279" "5342999" "5351393" "5371404" "5376825" "5390412" "5418471" "5508556" "5536362" "5569955" "5575688" "5578870" "5593322" "5611884" "5634821" "5639247" "5641309" "5645433" "5646442" "5702255" "5824950" "5854512").PN. OR ("6097086").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 16:06

S14	35	("4656605" "4684184" "4696525" "4727513" "4833568" "4850892" "4868712" "4953060" "5241450" "5330359" "5376825" "5380681" "5383269" "5426563" "5429511" "5445526" "5455740" "5481133" "5502667" "5512783" "5543660" "5586009" "5612570" "5619067" "5666272" "5726493" "5734555" "5821625" "5963430").PN. OR ("6093029").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 16:08
S15	24	("5237202" "5241133" "5285352" "5334857" "5397917" "5433822" "5455456" "5508556" "5539153" "5551148" "5552635" "5569955" "5592025" "5598321" "5635671" "5689091").PN. OR ("5854512").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 16:09
S16	18	("5332864" "5442230").PN. OR ("5569955").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 16:10
S17	23	("5006922" "5102829" "5172303" "5200366" "5291062" "5334857" "5433822" "5455456" "5468999" "5608265").PN. OR ("5726493").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 16:11
S18	709	(257/735-736).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/14 15:14
S19	3000	(257/737-738).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/14 15:14
S20	74	S18 and S19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 15:16

S21	2046	(257/784).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/14 15:17
S22	261	S19 and S21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 15:17
S23	45797	electronic adj circuitry	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 16:29
S24	602	S23 and (electronic adj circuitry) with (insulated insulating dielectric)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 16:29
S25	2	("4878846").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/14 16:27
S26	26	("3571915" "4330812" "4688150").PN. OR ("4878846").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/14 16:27
S27	11	S26 and electronic	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/14 16:28
S28	127869	electronic adj circuit	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 16:29
S29	4212	S28 and (electronic adj circuit) with (insulated insulating dielectric)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 16:30

S30	27	S29 and (second adj connection)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 16:30
S31	2389	(printed adj circuit) same (dielectric adj layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 08:29
S32	117	S31 and (electronic adj circuitry)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 08:29
S33	6	hemi-spherical adj bump	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 09:33
S34	189	hemispherical adj bump	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/15 09:33
S35	528	(257/735).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/26 13:37
S36	3021	(257/737-738).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/26 13:37
S37	52	S35 and S36	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/26 13:44

S38	217	(257/736).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/26 13:52
S39	2587	(257/778).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/26 13:53
S40	1	S39 and ("2425")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/26 13:53
S41	60	S39 and ("24 25")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/26 13:53
S42	916	S39 and (S35 S36)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/26 13:54
S43	899	S42 not (S37 S38)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/26 13:54